

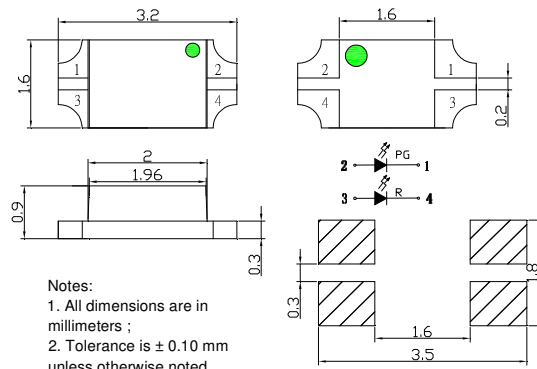
■Features

- Bi-Color
- Super high brightness of surface mount LED
- Water Clear Flat Mold
- Compact package outline
(LxWxT) of 3.2mm x 1.6mm x 0.9mm
- Compatible to IR reflow soldering.

■Applications

- Backlighting (switches, keys, etc.)
- Marker lights (e.g. steps, exit ways, etc.)

■Outline Dimension



Notes:
1. All dimensions are in millimeters ;
2. Tolerance is ± 0.10 mm unless otherwise noted.

Recommended Soldering Pattern
(Units : mm)

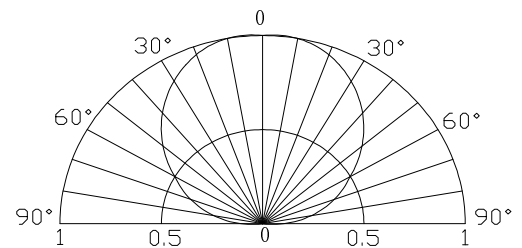
■Absolute Maximum Rating

(Ta=25°C)

Item	Symbol	Value		Unit
		Red	PG	
DC Forward Current	I _F	30	30	mA
Pulse Forward Current*	I _{FP}	100	100	mA
Reverse Voltage	V _R	5	5	V
Power Dissipation	P _D	78	108	mW
Operating Temperature	T _{opr}	-40 ~ +85		°C
Storage Temperature	T _{stg}	-40~ +85		°C
Lead Soldering Temperature	T _{sol}	260°C/10sec		-



*Pulse width Max 0.1ms, Duty ratio max 1/10

■Directivity



■Electrical -Optical Characteristics

(Ta=25°C)

Part Number	Color			V _F (V)			I _R (μA)	I _v (mcd)			λD(nm)			2θ1/2(deg)
				Min.	Typ.	Max.	Max.	Min.	Typ.	Max.	Min.	Typ.	Max.	Typ.
				I _F =20mA			V _R =5V	I _F =20mA						
OSRG1206C1F	Red	HR		1.8	2.1	2.6	10	-	100	-	620	625	630	120
	Pure green	PG		2.6	3.1	3.6	10	-	350	-	515	525	530	120

*1 Tolerance of measurements of dominant wavelength is ±1nm

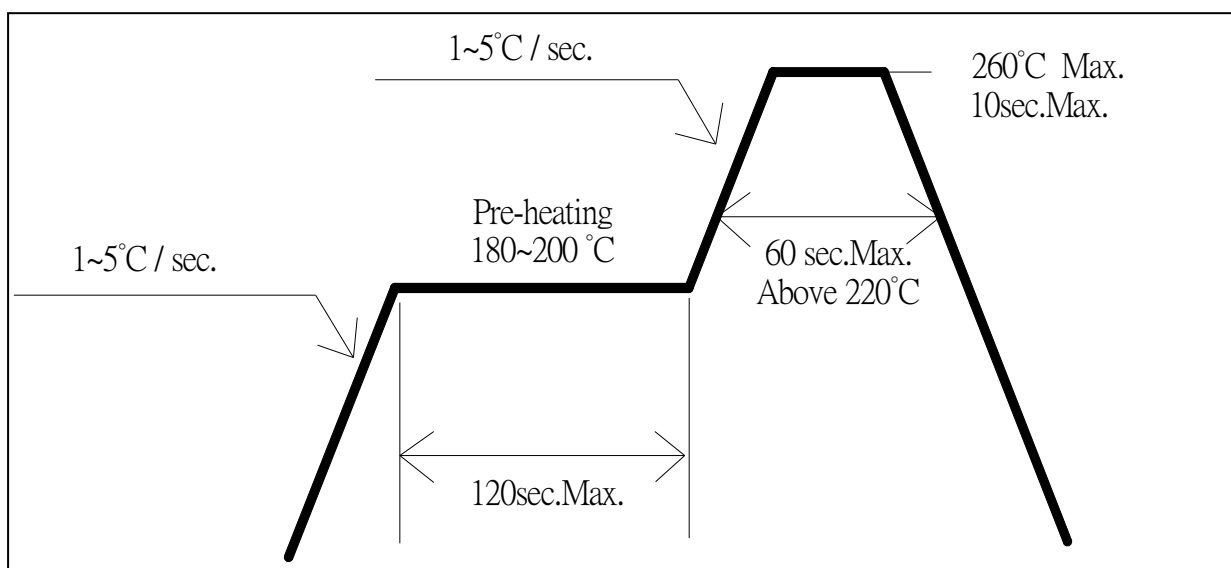
*2 Tolerance of measurements of luminous intensity is ±15%

*3 Tolerance of measurements of forward voltage is ±0.1V

■ Soldering Conditions

Reflow Soldering		Hand Soldering	
Pre-Heat	180 ~ 200°C	Temperature Soldering time	350°C Max. 3 sec. Max. (one time only)
Pre-Heat Time	120 sec. Max.		
Peak temperature	260°C Max.		
Dipping Time	10 sec. Max.		
Condition	Refer to Temperature-profile		

• Reflow Soldering Condition(Lead-free Solder)



*Recommended soldering conditions vary according to the type of LED

*Although the recommended soldering conditions are specified in the above table, reflow, or hand soldering at the lowest possible temperature is desirable for the LEDs.

*A rapid-rate process is not recommended for cooling the LEDs down from the peak temperature.

• All SMD LED products are pb-free soldering available.

• Occasionally there is a brightness decrease caused by the influence of heat or ambient atmosphere during air reflow. It is recommended that the User use the nitrogen reflow method.

• Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable a double-head soldering iron should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

• Reflow soldering should not be done more than two times.

• When soldering, do not put stress on the LEDs during heating.

• After soldering, do not warp the circuit board.

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